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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/653,411	08/31/2000	Whonchee Lee	M4065.0361/P361	5349

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DICKSTEIN SHAPIRO MORIN & OSHINSKY LLP  
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[REDACTED] EXAMINER

NGUYEN, JOSEPH H

ART UNIT	PAPER NUMBER
2815	

DATE MAILED: 04/24/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

<b>Office Action Summary</b>	Application No.	Applicant(s)	
	09/653,411	LEE ET AL.	
	Examiner	Art Unit	
	Joseph Nguyen	2815	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --  
**Period for Reply**

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).
- Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

#### Status

- 1) Responsive to communication(s) filed on 25 February 2003.
- 2a) This action is FINAL.      2b) This action is non-final.
- 3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

#### Disposition of Claims

- 4) Claim(s) 39-51 is/are pending in the application.
- 4a) Of the above claim(s) \_\_\_\_\_ is/are withdrawn from consideration.
- 5) Claim(s) \_\_\_\_\_ is/are allowed.
- 6) Claim(s) 39-51 is/are rejected.
- 7) Claim(s) \_\_\_\_\_ is/are objected to.
- 8) Claim(s) \_\_\_\_\_ are subject to restriction and/or election requirement.

#### Application Papers

- 9) The specification is objected to by the Examiner.
- 10) The drawing(s) filed on 31 August 2000 is/are: a) accepted or b) objected to by the Examiner.  
 Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- 11) The proposed drawing correction filed on \_\_\_\_\_ is: a) approved b) disapproved by the Examiner.  
 If approved, corrected drawings are required in reply to this Office action.
- 12) The oath or declaration is objected to by the Examiner.

#### Priority under 35 U.S.C. §§ 119 and 120

- 13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) All b) Some \* c) None of:  
 1. Certified copies of the priority documents have been received.  
 2. Certified copies of the priority documents have been received in Application No. \_\_\_\_\_.  
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- \* See the attached detailed Office action for a list of the certified copies not received.
- 14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).  
 a) The translation of the foreign language provisional application has been received.
- 15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

#### Attachment(s)

- |  |   |
|--|---|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892)                             | 4) <input type="checkbox"/> Interview Summary (PTO-413) Paper No(s). _____  |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948)         | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449) Paper No(s) _____ | 6) <input type="checkbox"/> Other: _____                                    |

**DETAILED ACTION**

***Claim Rejections - 35 USC § 102***

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless –

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 39- 47, 49-50 are rejected under 35 U.S.C. 102(b) as being anticipated by Lee et al (2001/0025976 A1).

Regarding claim 39, Lee et al discloses on figure 5 a semiconductor device comprising a substrate 31 and at least one electron mechanically polished metal layer 53 formed over said substrate 31, said electro mechanically polished metal layer containing no hardening additive.

It should be noted that the term “electro-mechanical polished” merely recites product by process and does not structurally distinguish the metal layer from the structure taught by Lee et al.

Regarding claim 40, Lee et al disclose on figure 5 the metal layer 53 comprises at least one metal selected from the group consisting of noble metals, noble metal alloys, refractory metals and refractory metal alloys.

Regarding claim 41, Lee et al disclose on figure 5 the device comprises a capacitor with at least one electro mechanical polished metal layer 53.

Regarding claim 42, Lee et al disclose on figure 5 the electro-mechanical polished metal layer 53 is bottom electrode of said capacitor.

Regarding claim 43, as best, Lee et al disclose on figure 5 a semiconductor device comprising a bottom electrode 53 formed over a substrate 31; an insulating layer 55 formed over the bottom electrode; and a top electrode 57 formed over the insulating layer 55, wherein at least one electrode surface comprises an electro mechanically polished surface, said electro mechanically polished metal layer containing no hardening additive.

Regarding claim 44, Lee et al disclose on figure 5 the capacitor is a MIM capacitor.

Regarding claim 45, Lee et al disclose on figure 5 at least one electrode 53 comprises a metal selected from the group consisting of noble metals, noble metal alloys, refractory metals and refractory metal alloys.

Regarding claim 46, Lee et al disclose on figure 5 at least one electrode surface is a surface of the bottom electrode 53.

Regarding claim 47, Lee et al disclose on figure 5 the bottom electrode 53 comprises a platinum electrode.

Regarding claim 49, Lee et al discloses on figure 5 a semiconductor device comprising a substrate 31; and at least one electro-mechanically polished metal layer 53 consisting of a noble metal formed.

Regarding claim 50, Lee et al discloses on figure 5 a semiconductor device comprising a bottom electrode 53 formed over a substrate 31; an insulating layer 55 formed over said bottom electrode; and a top electrode 57 formed over said insulating

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layer, wherein at least one electrode surface comprises an electro mechanically polished noble metal surface.

***Claim Rejections - 35 USC § 103***

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 48 and 51 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lee et al in view of Sandhu et al.

Regarding claims 48 and 51, Lee et al disclose substantially all the structure set forth in the claimed invention except a memory device electrically coupled to a processor. However, Sandhu et al disclose on figure 20 a memory device 1100 electrically coupled to a processor. In view of such teaching, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify Lee et al by having a memory device electrically coupled to a processor for the purpose of improving the performance of the integrated circuits.

***Response to Amendment***

Applicant's arguments with respect to claims 39-51 have been considered but are moot in view of the new ground(s) of rejection.

Applicant's amendment necessitated the new ground(s) of rejection presented in this Office action. Accordingly, **THIS ACTION IS MADE FINAL**. See MPEP § 706.07(a). Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the date of this final action.

### ***Conclusion***

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Joseph Nguyen whose telephone number is (703) 308-1269. The examiner can normally be reached on Monday-Friday, 7:30 am- 4:30 pm

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Eddie Lee can be reached on (703) 308-1690. The fax phone numbers for the organization where this application or proceeding is assigned is (703) 308-7382 for regular communications.

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Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

JN

April 21, 2003



EDDIE LEE  
SUPERVISORY PATENT EXAMINER  
TECHNOLOGY CENTER 2800